Electronic Pate	ent App	lication Fee	Transm	ittal			
Application Number:	105	10581675					
Filing Date:	05-	05-Jun-2006					
Title of Invention:		ELECTROCONDUCTIVE RESIN COMPOSITION AND MOLDED PRODUCT THEREOF					
First Named Inventor/Applicant Name:	Tac	Tadashi lino					
Filer:	Joh	John Timothy Callahan/Sharon Slater					
Attorney Docket Number:	Q7	Q78933					
Filed as Large Entity	,						
U.S. National Stage under 35 USC 371 Fi	ling Fee	5					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Utility Appl issue fee		1501	1	1510	1510		

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			1810